

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3	(infrared and sensor and substrate and adhesive and (heat with conductiv\$5)).clm.	US-PGPUB; USPAT	OR	ON	2005/09/24 14:45
S1	1	10/811873	US-PGPUB	OR	OFF	2005/09/24 14:44
S2	25200	(infrared adj (sensor or detector))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/20 11:51
S3	1891	S2 and adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:37
S4	12	S3 and (adhesive with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:41
S5	9	S4 and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:41
S6	22	S3 and ((adhesive or bond\$4) with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:41
S7	19	S6 and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:41
S8	92	((infrared adj (sensor or detector)) with (mount\$4 near3 substrate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 09:51
S9	13	S8 and (heat near conduct\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:04
S10	5283	"6" and ((adhesive or bond\$4) with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:01

S11	92	((infrared adj (sensor or detector)) with (mount\$4 near3 substrate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 14:10
S12	2	S11 and ((adhesive or bond\$4) with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:13
S13	4	S11 and ((adhesive or bond\$4) same (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:17
S14	1	("4111717").PN.	USPAT	OR	OFF	2005/04/25 10:56
S15	1	"20040188618"	US-PGPUB	OR	OFF	2005/04/25 10:57
S16	25281	(infrared adj (sensor or detector))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:06
S17	8	S16 same ((adhesive or bond\$4) with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:02
S18	12	((infrared adj (sensor or detector)) same (silicon\$3 with adhesive)) and mount\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:06
S19	6	S18 and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:06
S20	12	((infrared adj (sensor or detector)) same (silicon\$3 with adhesive)) and mount\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:40
S21	1	("5056929").PN.	USPAT	OR	OFF	2005/04/25 11:40
S22	20	(infrared adj (sensor or detector)) and (((hot or cold) near contact) with (cover or film))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:50

S23	620	(infrared adj (sensor or detector)) and 250/338.1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:51
S24	20	(infrared adj (sensor or detector)) and (((hot or cold) near contact) with (cover or film))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:51
S25	2	S23 and S24	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:51
S26	2844	conductivity with w/mk	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 14:10
S27	522	S26 and (infrared (sensor or detector)).	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 14:10
S28	349	S27 and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 14:11
S29	122	S28 and adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 14:11
S30	42	S29 and thermocouple	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 14:11
S31	32	S30 and silicon\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 14:12
S32	1	S31 and ((hot or cold) near2 contact)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 14:12

S33	28802	(infrared near (sensor or detector))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/20 11:57
S34	515	S33 same thermopile	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/20 11:57
S35	3	S34 and ((adhesive or bond\$4 or glu\$4) with (heat near2 conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/20 11:59
S36	2	S35 and gas	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:18
S37	28802	(infrared near (sensor or detector))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:19
S38	6307	S37 and gas	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:19
S39	290	S37 and (cavity with gas)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:22
S40	19	S39 and (mount\$4 with (infrared near (sensor or detector)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:19
S41	4	S40 and adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:22
S42	1842	250/338.1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:22

S43	37	S42 and (cavity with gas)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:25
S44	5	S43 and adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:23
S45	17	S42 and substrate and mount\$4 and adhesive and gas	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:28
S46	75	(adhesive with (low near (heat near conduct\$6)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:29
S47	151	((bond\$5 or adhesive) with (low near (heat near conduct\$6)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:29
S48	1	S42 and S47	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:29
S49	2	S37 and S47	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:40
S50	1	(AKIGUCHI and MASAYOSHI).in. and (infrared near detector)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/21 12:40